

2026 International Conference on Electromagnetics in Advanced Applications and IEEE-APS Topical Conference on Antennas and Propagation in Wireless Communications (ICEAA – IEEE APWC 2026)

Sponsorship Prospectus

ICEAA – IEEE APWC 2026 Organizing Committee



**SEPTEMBER 14-18, 2026
TOYAMA, JAPAN**

Message from ICEAA – IEEE APWC 2026 Conference Chairs

On behalf of the organizers, we are pleased to invite you to the 2026 edition of ICEAA and IEEE APWC (ICEAA – IEEE APWC 2026), scheduled to take place in Toyama, Japan from 14th to 18th September 2026 – the first time this joint conference will be hosted in Asia. ICEAA – IEEE APWC 2026 is jointly sponsored by the Institute of Electronics, Information and Communication Engineers (IEICE) and Politecnico di Torino, with the technical co-sponsorships from IEEE Antennas and Propagation Society and International Union of Radio Science (URSI), and IOWN (Innovative Optical and Wireless Network) Global Forum. The purpose of the conference is to provide a platform for the presentation and exchange of cutting-edge research in electromagnetic field theory, antennas and propagation, and wireless communications.

While Toyama is compact in terms of its land, it is home to the 3,000-meter-high Tateyama Mountain Range (part of the Japan Northern Alps), as well as the 1,000-meter-deep Toyama Bay, which is recognized as a member of “The Most Beautiful Bays in the World Club.” In winter, a heavy snowfall on the Northern Alps provides abundant snowmelt that enriches the land and flows into Toyama Bay. This climate and distinct topography, featuring a 4,000-meter elevation difference, have produced majestic natural beauty, clear water, and rich agricultural and seafood products that have blessed this beautiful rural area for centuries.

The conference venue is located in the heart of Toyama City. Participants can enjoy nearby sightseeing attractions, including Toyama Castle Park, Fugan Canal Kansui Park, Fugan Canal Cruise, Toyama Prefectural Museum of Art & Design, and the Toyama Glass Art Museum. There are also shopping areas and restaurants offering local food and drinks.

Toyama City was selected by *The New York Times* as one of the “52 Places to Go in 2025.” The article highlights Toyama as a city where visitors can “Enjoy cultural wonders and culinary delights while skipping the crowds.” You can also experience Toyama’s history and culture through a visit of the UNESCO World Heritage Site, “The Historic Villages of Gokayama.” We also invite to you enjoy a ride on the scenic trolley train through eastern Toyama’s “Kurobe Gorge,” the deepest gorge in Japan. Toyama deserves several days to take in all that it has to offer. We hope you will fully enjoy Toyama’s exceptionally beautiful nature and historical experiences that are truly worth visiting. Only two hours by bullet train or one hour by airplane from Tokyo, and with easy access to Osaka and Nagoya, Toyama is located approximately in the center of Japan. With three daily direct domestic flights from Tokyo Haneda Airport to Toyama Kito Kito Airport – just a 20-minute drive from the venue – Toyama’s compactness makes it convenient for convention participants.

We would greatly appreciate your kind support and cooperation in line with the objectives and significance of the conferences. We are confident that, as a sponsor, you will gain greater visibility among the world’s leading researchers and practitioners in the field of electromagnetics, antennas and propagations, and wireless communications. If you have any questions or suggestions regarding the conference sponsorship, please feel free to contact us.

Don’t miss the opportunity to visit Toyama, Japan. We guarantee that you will fully enjoy your stay. We very much look forward to welcoming you to Toyama in September 2026.

ICEAA – IEEE APWC 2026 Conference Chairs



Roberto D. Graglia
Chair, Organizing Committee



Piergiorgio L. E. Uslenghi
Chair, Steering Committee



Francesco P. Andriulli
Chair, Scientific Committee



Guido Lombardi
Chair, Technical Program Committee



Kazuya Kobayashi
Chair, Local Organizing Committee

Overview of ICEAA – IEEE APWC 2026

1. Name of the Conference

ICEAA: International Conference on Electromagnetics in Advanced Applications, and
IEEE APWC: IEEE-APS Topical Conference on Antennas and Propagation in Wireless Communications
(ICEAA – IEEE APWC 2026)

2. Sponsors and Technical co-sponsors

- **Sponsored by:** The Institute of Electronics, Information and Communication Engineers (IEICE);
Politecnico di Torino
- **Technically co-sponsored by:** IEEE Antennas and Propagation Society (IEEE AP-S);
International Union of Radio Science (URSI); IOWN Global Forum

3. Dates

September 14 – 18, 2026 (5 days)

5. Venue

Toyama International Conference Center (1-2 Ote-machi Toyama 930-0084, Japan)
ANA Crowne Plaza Toyama (2-3 Ote-machi, Toyama 930-0084, Japan)

6. Participants

400 participants (domestic: 280 participants / overseas: 120 participants)

7. Website <https://www.iceaa-offshore.org/>



Overview of ICEAA – IEEE APWC 2026

8. Conference Chairs

- Chair, Organizing Committee

Roberto D. Graglia

Professor, Politecnico di Torino, Italy

- Chair, Steering Committee

Piergiorgio L. E. Uslenghi

Distinguished Professor Emeritus, University of Illinois Chicago, USA

- Chair, Scientific Committee

Francesco Andriulli

Professor, Politecnico di Torino, Italy

- Chair, Technical Program Committee

Guido Lombardi

Professor, Politecnico di Torino, Italy

- Chair, Local Organizing Committee

Kazuya Kobayashi

Professor Emeritus, Chuo University, Japan

Overview of ICEAA – IEEE APWC 2026

9. Organizing Committee

- Chair
Roberto D. Graglia
Professor, Politecnico di Torino, Italy
- Steering Committee
Piergiorgio L. E. Uslenghi
Distinguished Professor Emeritus, University of Illinois Chicago, USA
- Scientific Committee
Francesco Andriulli
Professor, Politecnico di Torino, Italy
- Technical Program Committee
Guido Lombardi
Professor, Politecnico di Torino, Italy
- Local Organizing Committee
Kazuya Kobayashi
Professor Emeritus, Chuo University, Japan
Hisamatsu Nakano
Professor Emeritus, Hosei University, Japan
- Treasurer
Kazuya Kobayashi
Professor Emeritus, Chuo University, Japan
- IEEE AP-S representative
Danilo Erricolo
University of Illinois at Chicago, USA
- URSI representative
Piergiorgio L. E. Uslenghi
Distinguished Professor Emeritus, University of Illinois Chicago, USA
- Secretariat/Administration
Manuela Trincherò
Laura Trincherò
SELENE Srl – Eventi e Congressi, Torino, Italy
- Local Secretariat
Yasushi Masuda
Masumi Hatta
Miku Oya
Convention Linkage, Inc., Japan
- Members
Paolo Petrini
Electronic Engineer, Politecnico di Torino, Italy
Ladislau Matekovits
Associate Professor, Politecnico di Torino, Italy
Hisamatsu Nakano
Professor Emeritus, Hosei University, Japan
Satoshi Yagitani
Professor, Kanazawa University, Japan
Keigo Ishisaka
Professor, Toyama Prefectural University, Japan

1. Sponsorship Packages



Sponsorship Packages

Max: 1

Platinum
¥ 1,000,000-

[Before conference]

- Sponsor logo promotion on ICEAA – IEEE APWC 2026 official website

[During conference period]

Signage logo promotion

- Information signs and room signs in the onsite venue

Advertisement

- Program Book (PDF)
- Slide or CM (movie) between sessions (Video slide, 1 min. per frame)
- Congress Bag Insert (One Item Only)

Other benefits

- Free admission to the conference (for 3 persons)

Max: 2

Gold
¥ 600,000-

[Before conference]

- Sponsor logo promotion on ICEAA – IEEE APWC 2026 official website

[During conference period]

Signage logo promotion

- Information signs and room signs in the onsite venue

Advertisement

- Program Book (PDF)

Other benefits

- Free admission to the conference (for 2 persons)

Max: 4

Silver
¥ 300,000-

[Before conference]

- Sponsor logo promotion on ICEAA – IEEE APWC 2026 official website

[During conference period]

Signage logo promotion

- Information signs in the onsite venue

Other benefits

- Free admission to the conference (for 1 person)

The sponsor packages include exhibition booth (s). For details, please also refer to page 11-12.

Type A: booth for Platinum and Gold

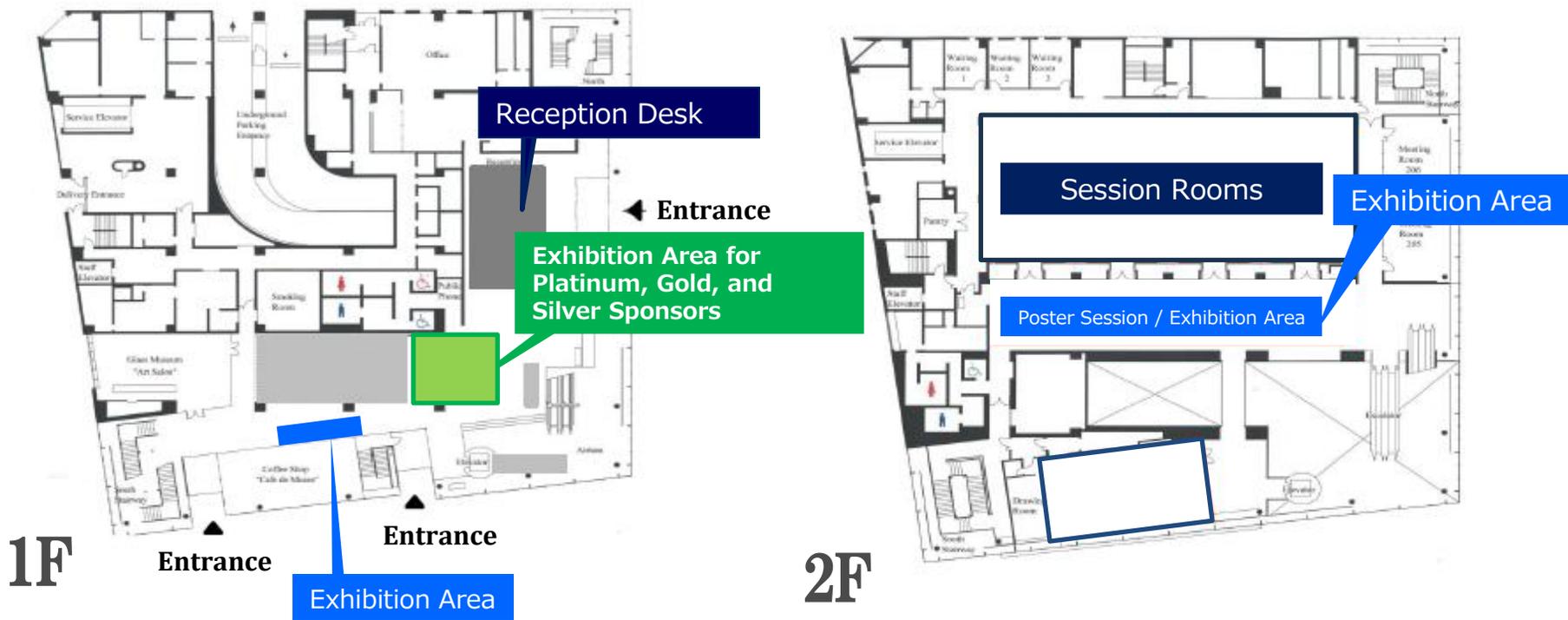
Type B: booth for Silver

Please let us know if you do not need an exhibition booth (Package fees remain the same.)

Sponsorship Packages

Items	Details	Platinum	Gold	Silver
		¥1,000,000 × 1	¥600,000 × 2	¥300,000 × 4
Exhibition	Type A	2	1	
	Type B			1
Logo Promotion	Information signs and room signs in the onsite venue	1	1	1 (Information sign only)
	Official Website	1	1	1
Advertisement	Program Book (PDF)	1	1	
	Slide or CM (movie) between sessions (Video slide, 1 min. per frame)	1		
	Congress Bag Insert (One Item Only)	1		
Other Benefits	Free admission to the conference	3	2	1

Sponsorship Booth Locations (Toyama International Conference Center)



The exhibition area is based on plans as of November 2025. Please note that it is subject to change without prior notice.

Sponsorship Packages Application

1) Application

**Please fill out the Application Form for Sponsorship (Form A) and send it by email or fax.
Invoice for payment will be issued after application confirmation.**

<Applications & Inquiries>

Secretariat for ICEAA – IEEE APWC 2026 (c/o Convention Linkage Co., Ltd.)
Sapporo Tokeidai Bldg., 2-1 Kita 1-Jo Nishi, Chuo-ku, Sapporo, Hokkaido, 060-0001, Japan
E-mail: iceaa2026_local_secretariat@c-linkage.co.jp

Application due date: Wednesday, May 13, 2026

2) Notifications:

- Cancellations will not be accepted after application.
- Please select a representative if you are applying for a joint sponsorship with group companies, organizations, or affiliated companies.

4) Cancellation of participation for uncontrollable or unforeseeable reasons:

- The organizer(s) reserves the right to cancel the event, shorten the event period or time, or postpone the event before or during the event period if conditions are so that it becomes extraordinarily difficult to hold the event caused, directly or indirectly, by a force majeure event, such as a natural disaster, spread of infectious disease, acts of terrorism, at the request of the national government or government agencies, or any other such similar cause that is beyond the reasonable control of the organizer(s). In this case, the organizer(s) will notify sponsors immediately after a decision has been reached. The organizer(s) will not be liable for any damages incurred as a result of this decision or its execution.
- If the event is cancelled due to force majeure prior to the event, the organizer(s) will refund the balance of the sponsorship fee after deducting expenses for costs already incurred.
- Sponsorship fees will not be refunded if the period or time of the event is shortened due to a force majeure that occurs during the event period. Sponsors will also not be compensated by the organizer(s) for any expenses incurred.

2. Exhibition Booth

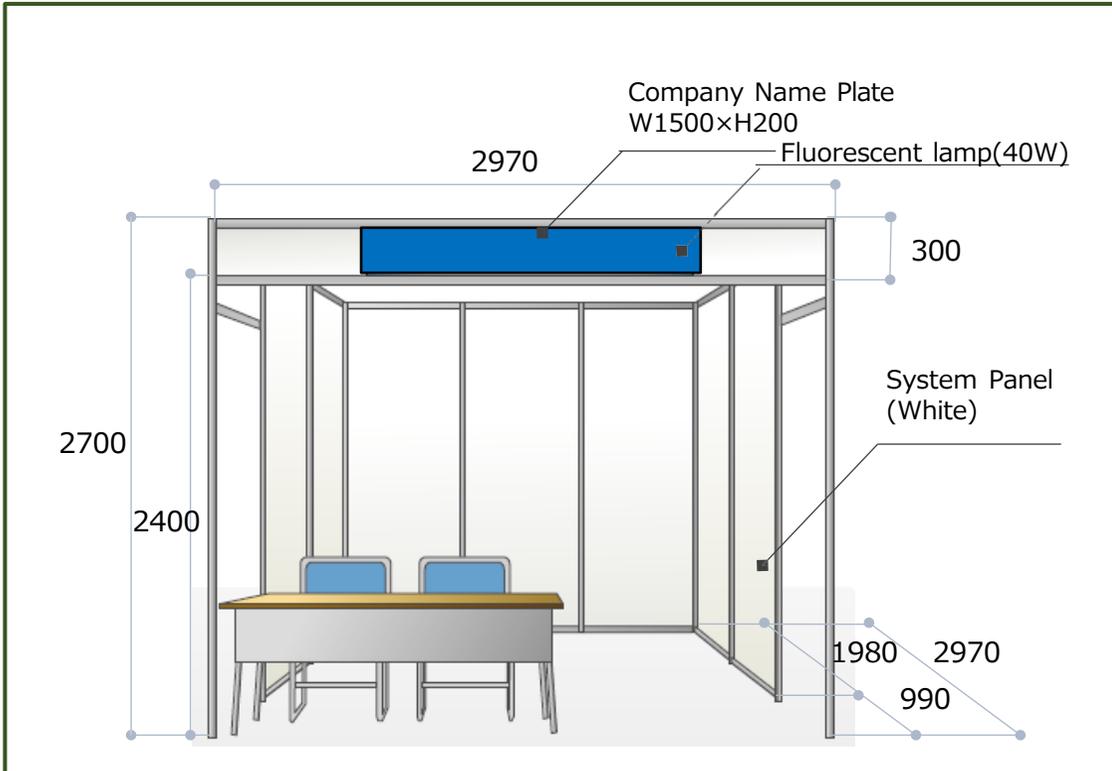


Exhibition Booth Application Guidelines (Type A)

1) Exhibition fee (Type A)

¥200,000 (incl. tax)/booth

2) Specifications for basic booth plan



※Design and contents are subject to change.

- | | |
|----------------------------------|-----------------------------|
| •System panel (white) : 3 | •Electricity : 100V / 0.5kW |
| •Table : 1 | •2-socket outlet : 1 |
| •Chair : 2 | |
| •Company sign : Company/org name | |
| •Tablecloth (white) : 1 | |

* The location of the exhibition booths will be decided by the organizers after the application deadline.
 * Additional charges apply for special decor/embellishments, electrical wiring, etc. Please contact the Secretariat for more details.

- If you apply for several booths, the layout may differ from the left image.
- If you use more power than 100V / 0.5kW, optional items application is required.

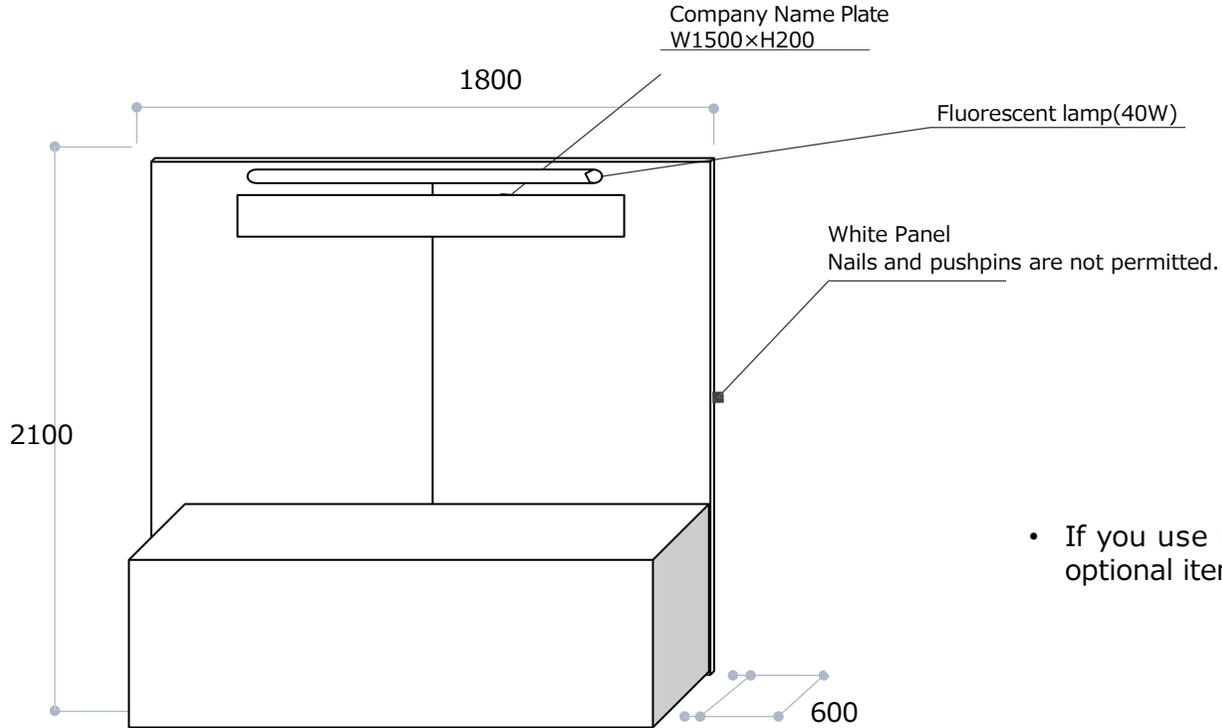
* Images are for illustrative purposes only.

Exhibition Booth Application Guidelines (Type B)

1) Exhibition fee (Type B)

¥100,000 (incl. tax) /booth

2) Specifications for basic booth plan



- | | | |
|-------------------------|-----------|-----------------------------------------|
| •System Panel(white) | : 2 sides | •Company Name Plate: Company / org name |
| •Table(W1800×D900×H700) | : 1 | •2-socket outlet : 1 |
| •Tablecloth (white) | : 1 | •Electricity : 100V / 0.5kW |

* Images are for illustrative purposes only.

Exhibition Booth Application

1) Application

**Please fill out the Application Form for Sponsorship (Form B) and send it by email or fax.
Invoice for payment will be issued after application confirmation.**

<Applications & Inquiries>

Secretariat for ICEAA – IEEE APWC 2026 (c/o Convention Linkage Co., Ltd.)

Sapporo Tokeidai Bldg., 2-1 Kita 1-Jo Nishi, Chuo-ku, Sapporo, Hokkaido, 060-0001, Japan

E-mail: iceaa2026_local_secretariat@c-linkage.co.jp

Application due date: Wednesday, May 13, 2026

2) Notifications:

- Cancellations will not be accepted after application.
- Please select a representative if you are applying for a joint sponsorship with group companies, organizations, or affiliated companies.

4) Cancellation of participation for uncontrollable or unforeseeable reasons:

- The organizer(s) reserves the right to cancel the event, shorten the event period or time, or postpone the event before or during the event period if conditions are so that it becomes extraordinarily difficult to hold the event caused, directly or indirectly, by a force majeure event, such as a natural disaster, spread of infectious disease, acts of terrorism, at the request of the national government or government agencies, or any other such similar cause that is beyond the reasonable control of the organizer(s). In this case, the organizer(s) will notify sponsors immediately after a decision has been reached.
The organizer(s) will not be liable for any damages incurred as a result of this decision or its execution.
- If the event is cancelled due to force majeure prior to the event, the organizer(s) will refund the balance of the sponsorship fee after deducting expenses for costs already incurred.
- Sponsorship fees will not be refunded if the period or time of the event is shortened due to a force majeure that occurs during the event period. Sponsors will also not be compensated by the organizer(s) for any expenses incurred.

ICEAA – IEEE APWC 2026 Application Form for Sponsorship Packages

Form A

Application for sponsorship as follows. Application date: YY/ MM/ DD

Company name ※Company name to be listed on printed matter and official website.

Address

Name of Representative:	Title/Department:
	Signature:

Name of Contact Person:	Title/Department:
	Signature:

TEL	FAX
-----	-----

E-mail

Company URL ※URL will be linked from the official website.
https://

- The location of exhibition booths will be determined by the Secretariat based on the order of applications.
- Please note that cancellations will not be accepted after this application. In case of cancellation, sponsors will be required to pay the full sponsorship fee.
- Invoice for payment will be issued after receipt of this application. Contents are subject to change without notice.
- Please contact the Secretariat for confirmation and questions.

Application Due Date: May 13, 2026

Check your preferred sponsorship package

Application for Sponsorship Packages

- | | |
|-----------------------------------|-------------------------------|
| <input type="checkbox"/> Platinum | ¥1,000,000 (incl. tax) |
| <input type="checkbox"/> Gold | ¥600,000 (incl. tax) |
| <input type="checkbox"/> Silver | ¥300,000 (incl. tax) |

Total (incl. tax) ¥

■ Contact Information ■

Secretariat for ICEAA – IEEE APWC 2026
(c/o Convention Linkage, Inc.)
TEL : +81-11-272-2151
E-mail : iceaa2026_local_secretariat@c-linkage.co.jp

